

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JONG SEOK YANG	12/06/2017
KI JOUNG LEE	12/06/2017
GEUN BAE JEON	12/06/2017
BAEG YONG SEONG	12/06/2017
DONG HA PARK	12/06/2017
RECEIVING PARTY DATA	
Name:	DYM SOLUTION CO., LTD.
Street Address:	50, 2GONGDAN 8-GIL, SEOBUK-GU
Internal Address:	CHUNGCHEONGNAM-DO
City:	CHEONAN-SI
State/Country:	KOREA, REPUBLIC OF
Postal Code:	31075
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15835305
CORRESPONDENCE DATA	
Fax Number:	(971)271-8021
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	(971) 271-8020
Email:	foreigninbound@mccrus.com
Correspondent Name:	MCCOY RUSSELL LLP
Address Line 1:	806 SW BROADWAY
Address Line 2:	SUITE 600
Address Line 4:	PORTLAND, OREGON 97205-3335
ATTORNEY DOCKET NUMBER:	PLS17323
NAME OF SUBMITTER:	LENA GEUPEL
SIGNATURE:	/Lena Geupel/
DATE SIGNED:	12/07/2017

Total Attachments: 2

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ASSIGNMENT

WHEREAS, I/we, the following named inventor(s):

1. YANG, Jong Seok, Chungcheongnam-do, Republic of Korea;
2. LEE, Ki Joung, Chungcheongnam-do, Republic of Korea;
3. JEON, Geun Bae, Chungcheongnam-do, Republic of Korea;
4. SEONG, Baeg Yong, Seoul, Republic of Korea; and
5. PARK, Dong Ha, Seoul, Republic of Korea;

have invented an invention entitled **SEMI-CONDUCTIVE COMPOSITION FOR POWER CABLE**, for which I/we have executed an application for Letters Patent of the United States (check one):

(X) on the date I/we executed this assignment;

() as U.S. Patent Application No. _____, filed _____;

() as International Application No. _____, filed _____;

I/we authorize the attorneys/agents authorized to act under Customer Number 145572 to insert the filing date and application number of said application when known.

WHEREAS, **DYM SOLUTION CO., LTD.** ("Assignee"), a(n) Republic of Korea organization, having its principal place of business at 50, 2gongdan 8-gil, Seobuk-gu, Cheonan-si, Chungcheongnam-do 31075 Republic of Korea, is desirous of acquiring an interest therein;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I/we, the above named inventor(s), have sold, assigned, and transferred, and by these presents do sell, assign, and transfer unto Assignee, the full and exclusive right to the above-identified invention in the United States and its territorial possessions and in all foreign countries, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries, and in and to any and all divisions, reissues, continuations and extensions thereof, and all priority rights under all present or future conventions and treaties, and any provisional applications for which priority is claimed.

I/We hereby authorize and request the Patent Office officials in the United States and any and all foreign countries to issue any and all of said Letters Patent, when granted, to Assignees, as the assignees of my/our entire right, title and interest in and to the same, for the sole use of the Assignees, their successors and assigns.

Further, I/we agree that I/we will communicate to Assignees, or their representatives, any facts known to me/us respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitution, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to Assignees, make all rightful oaths and generally do everything possible to aid Assignees, their successors and assigns, to obtain and enforce proper protection for said invention in the United States and in any and all foreign countries.

IN TESTIMONY WHEREOF, I/we have hereunto set my/our hand(s) on the dates indicated below.

1. Inventor Name:	<u>YANG, Jong Seok</u>	Signature:	<u>[Signature]</u>	Date:	<u>12/06/2017</u>
2. Inventor Name:	<u>LEE, Ki Joung</u>	Signature:	<u>[Signature]</u>	Date:	<u>12/06/2017</u>
3. Inventor Name:	<u>JEON, Geun Bae</u>	Signature:	<u>[Signature]</u>	Date:	<u>12/06/2017</u>
4. Inventor Name:	<u>SEONG, Baeg Yong</u>	Signature:	<u>[Signature]</u>	Date:	<u>12/06/2017</u>

5. Inventor Name: PARK, Dong Ha Signature: PARK Dong Ha Date: 12/06/2017